## **PATENT**



Case Docket No. MICRON.076DV1

Date: October 21, 2002

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In re application of:

Weimin Li

App. No.

10/033,656

Filed

December 27, 2001

For

LOW DIELECTRIC

CONSTANT MATERIAL FOR

INTEGRATED CIRCUIT

**FABRICATION** 

Examiner

Jamie Lynn Brophy

Art Unit

2822

attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: United States Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on

I hereby certify that this correspondence and all marked

Oct. 21,2007

Adeal S Alchter Reg No. 41 304

UNITED STATES PATENT AND TRADEMARK OFFICE

P.O. Box 2327

Arlington, VA 22202

Sir:

Transmitted herewith is an amendment in the above-identified application.

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The fee has been calculated as shown below:

001 28 2002

		CLA	IMS AS FILED	)		
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	10		20	= 0 ×	\$18	= \$0
Independent Claims	2	<del></del>	3	= 0 ×	\$84	= \$0
If application has bee dependent claim(s),		ntain multiple			\$280	= \$0
Time Extension Fee				<del>-;</del>		\$0
			1	TOTAL ADD FOR THIS A		

- (X) Enclosed, please find one (1) amended drawing, with the amendments marked in red.
- (X) Return prepaid postcard.
- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

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Date: October 18, 2002

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(X) Please use Customer No. 20,995 for the correspondence address.

Adeel S. Akhtar Registration No. 41,394 Attorney of Record Customer No. 20,995 (415) 954-4114

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PATENT-

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant	:	Weimin Li	) Group Art Unit: 2822
Appl. No.	:	10/033,656	I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an
Filed	:	December 27, 2001	envelope addressed to: United States Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on
For	:	LOW DIELECTRIC CONSTANT MATERIAL FOR INTEGRATED CIRCUIT FABRICATION	October 21, 2002  (Date)  Adeel S. Akhtar, Reg. No. 41,394

## AMENDMENT AND RESPONSE TO OFFICE ACTION

United States Patent and Trademark Office P.O. Box 2327 Arlington, VA 22202

Dear Sir:

Examiner

In response to the Office Action mailed May 8, 2002 (the "Office Action"), Applicant respectfully requests entry of the following amendments and reconsideration of the rejections in view of the remarks below.

## IN THE CLAIMS:

Please amend the claims as set forth below.

1. (Amended) A unitary layer of insulating material directly contacting and formed between conductive elements in an integrated circuit, comprising a polysiloxane network consisting essentially of silicon, oxygen, carbon and hydrogen and incorporating carbon-silicon bonding and having a dielectric constant of less than about 3.3.

5. (Amended) An integrated circuit, comprising:

Jamie Lynn Brophy

a first conductive element providing a first electrical path of the circuit;

a second conductive element providing a second electrical path of the circuit; and

a unitary insulating layer directly contacting and sandwiched between the first and

second conductive elements, the insulating layer comprising polysiloxane, consisting

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